

### **Overview**



- Why is power a problem?
- What can FPGA's do?
- Are we safe now ?
- What else can FPGA's do?
- Summary

## The Shrink and Its Impact



Speed



Cost



Power



MPSoC 2008

Copyright 2008 Actel Corporation - Yankin Tanurhan

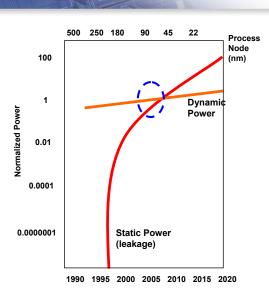
6/25/2008

3

### Semiconductor Industry Challenges



- Static power increases significantly at <100nm geometries</li>
- Subthreshold Leakage
  - Raising VT helps, but there's a limit.
  - Strain helps, but that's already been done
  - Worsens with reduced voltage
- Power and Speed at Odds
- Power is becoming a market limiter



Source: Int'l Technology Roadmap for Semiconductors (ITRS)

### **What about Dynamic Power**



#### Power = $CV^2F$

- Low K helps, but C is going up due to higher densities
- Fell previously, but now same
- Increasing steadily

MPSoC 2008

Copyright 2008 Actel Corporation - Yankin Tanurhan

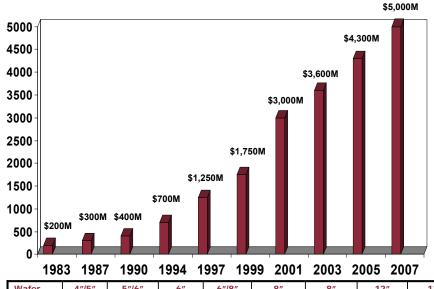
6/25/2008

## Semiconductor Fab Cost Trend Acte



#### Rising Fab Cost

Source: UMC



Wafer 4"/5" 5″/6″ 6"/8" 8 12 Process 1.2um 1.0um 0.8um 0.35um 0.25um 0.13um 0.09um 0.5um

# Trends Continue to Drive Demand for Low-power FPGAs



- Portable and battery-operated electronics proliferation
- Hyper-competitive markets with shorter product lifecycles and evolving standards
  - Increasing need for interfacing, bridging and control
- Power budgets tighten
  - Features, performance and complexity grow, but not at expense of draining the battery or increasing footprint
- Static power consumption and low-power modes most important for portables





MPSoC 2008

Copyright 2008 Actel Corporation - Yankin Tanurhan

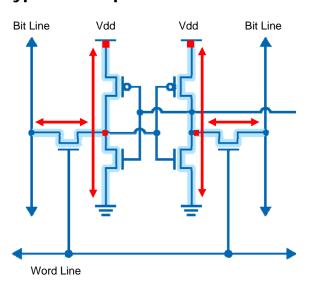
6/25/2008

7

### Flash's Fundamental Advantage



#### **Typical Competitors SRAM Cell - 6T**







- Substantial Leakage per Cell
- High Static Current

- Negligible leakage per cell
- Ultra Low Static Current

# What did we do in Technology and Design



- Integrate Flash and High Speed embedded logic process
- Deploy Low Power Vt options, Multiple Threshholds
- Single supply for core and I/Os
  - As low as 1.2V
- Seamless Low Power Power modes
  - Static, Flash\*Freeze
- Feature-Rich
  - RAM, PLL, I/O Standards, Cortex-M1

MPSoC 2008

Copyright 2008 Actel Corporation - Yankin Tanurhan

6/25/2008

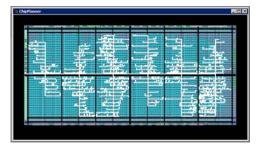
a

### **Power-Aware Tools**

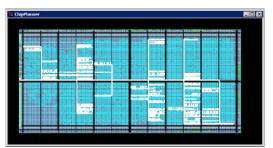


- Power Driven Layout
  - Yields lowest power consumption possible
  - Reduces dynamic power by 30%

#### **Timing-driven layout**



#### Power-driven layout

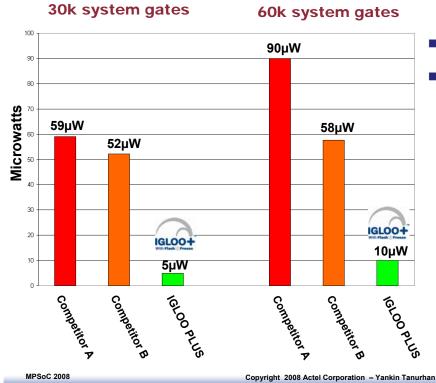


#### SmartPower

- Create Power profiles based on functional modes
- Cycle-accurate analysis
- Spurious transitions analysis
- Battery life estimation tool
- Enable Variable Voltage use modes

### **A Static Power Comparison**





- IGLOO PLUS 5µW
- Competitors
  - "Low-power CPLDs"
  - SRAM-based, lowpower PLDs
  - 10x higher power

6/25/2008

# Declare victory and go home.





# **Server Room**









MPSoC 2008

Copyright 2008 Actel Corporation - Yankin Tanurhan

6/25/2008

13

## **Server Math**



#### **Power for:**

100%	Server
60 %	Fan and Air Conditioning
60%	Switch, Router and Network
220%	

**IE Total Power = 2.2x Server Power** 

### Press Coverage: Server Farms



- 4 Google
  - 2 North Carolina
  - 1 South Carolina
  - 1 Oregon
- 1 MicroSoft Washington
- 1 Yahoo Washington



- All close to cheap, plentiful power
- 1.2% of electricity consumed in the US is used in server farms

"Energy costs will soon eclipse hardware costs. Possibly by a large margin."

Luiz Barroso. Google

MPSoC 2008

Copyright 2008 Actel Corporation - Yankin Tanurhan

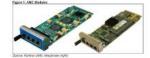
6/25/2008

15

### Industry is reacting with System Management Standards



- Telecommunications Computing Architecture (TCA)
  - Standards by PCI Industrial Computer Manufacturers Group (PICMG)
- Advanced Telecommunications Computing Architecture (ATCA)
  - December 2002 PICMG standard
  - Current rev of std is PICMG 3.0 R2.0 ECN002 adopted 29 April 2006
  - Architecture for high-performance, high-density, packet-based systems
- Advanced Mezzanine Card (AMC)
  - January 2005 PICMG standard
  - Current rev of std is <u>PICMG AMC.0 R2.0</u> adopted 15 November 06
  - Extends ATCA's high-bandwidth multi-protocol interface to hot-swappable modules for easy design, scaling, servicing





- July 2006 PICMG standard
- Current rev of std is <u>PICMG MTCA.0 R1.0</u> adopted 06 July 2006
- Smaller form-factor chassis delivers central power management, lower cost, high availability



- 1995 standard initiated by Intel. Dell, HP, Intel and NEC announced IPMI v1.0 on 16 September 1998
- Current rev of std is <u>IPMI v2.0 rev. 1.0 specification markup for IPMI v2.0/v1.5 errata revision 3</u> dated 15 February 2006
- Intelligent Platform Management Bus (IPMB) defines internal management bus for extending platform management within a chassis
- Intelligent Chassis Management Bus (ICMB) defines external management bus between IPMI enabled systems
- ATCA, AMC, MicroTCA all communicate using IPMI protocol



# Our customers are in need of System Management



- Manage Power Up: Power Sequencing, Status Monitoring
- Monitor Sensors and Report Status, Sensor Data
  - Temperature
  - Voltage
  - Current
  - Boot Status
- Take Immediate Actions based on Sensor Readings
  - Over/undervoltage/current/temp
- Communicate with System Controllers/Hubs
  - Oversee system inventories
  - Implement system-level redundancy
  - Manage Hot Swap
  - Respond to management queries and commands

MPSoC 2008

Copyright 2008 Actel Corporation - Yankin Tanurhan

6/25/2008

17

### **Summary**



- Power-conscious design is becoming more critical
  - Not only choice of components but designing smart for power
- You can minimize power consumption today
  - Innovative low-power FPGAs and programmable system chips
  - Power optimization tools
- At 5µW, Actel's IGLOO family is the low-power PLD leader
- We continue to expand our Power Concious FPGA portfolio with families like Fusion to adress power management needs